Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
SI	19	09/466934	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/04 09:48
S2	61918	SOI	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/29 20:11
S3	4425	S2 and (substrate with (insulat\$3 oxide box) with (semiconductor near (layer film)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 14:39
S4	633	S3 and recess\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/29 20:14
S5	542	S4 and (source drain)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/29 20:14
S6	448	S5 and isolat\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/29 20:14
S7	453	S5 and (isolat\$3 STI LOCOS)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 12:28
S8 .	416	S7 and gate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 12:29

			г			
S9	. 360	S8 and channel	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 12:28
S10	84	S9 and (recess\$2 with (source drain))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 12:27
SII	61918	SOI	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 12:27
S12	505	S11 and (recess\$2 with (source drain))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 14:40
S13	339	S12 and (isolat\$3 STI LOCOS)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 12:28
S14	286	S13 and channel	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 12:28
S15	275	S14 and gate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 12:29
S16	23	("4788160" "4851257" "5089872" "5168072" "5242847" "5314832" "5336903" "5338698" "5453389" "5571744" "5618755" "5665646" "5686331" "5702972" "5707721" "5710450" "5716861" "5763932" "5793089" "5851891" "6087706" "6124189" "6165826").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/30 13:13

	1		·			
S17	17	("4788160" "4851257" "5168072" "5314832" "5338698" "5618755" "5665646" "5686331" "5707721" "5710450" "5736435" "5739573" "5759886" "5783486" "5795808" "5889331" "RE35111").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/30 13:20
S18	4	("4485550" "4873204" "4905073" "5053848").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/04/30 13:22
S19	1952	SOI with (substrate with (insulat\$3 oxide box) with (semiconductor near (layer film)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 14:40
S20	43	S19 and (recess\$2 with (source drain))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/04/30 14:41
S21	0	gate near2 angle near2 (side near surface near recess\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/03 19:00
S22	3	gate with angle with (side near surface near recess\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/03 19:04
S23	2	(semiconductor near (layer film)) with angle with (side near surface near recess\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/03 19:13
S24	135	angle with (side near surface near recess\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/05/03 19:14
S25	6	S24 and SOI	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR .	ON	2005/05/03 19:14

S26	2	("6314021").PN.	US-PGPUB;	OR	OFF	2005/05/04 09:48
			USPAT;			
			USOCR;		ļ	
			EPO; JPO;			
			DERWENT		İ	
			; IBM_TDB			